

Title (en)
SYSTEM FOR CATION-ELECTRON INTRUSION AND COLLISION IN A NON-CONDUCTIVE MATERIAL

Title (de)
SYSTEM ZUR KATIONEN-ELEKTRONEN-INTRUSION UND KOLLISION IN EINEM NICHTLEITENDEN MATERIAL

Title (fr)
SYSTEME D'INTRUSION ET DE COLLISION CATION-ELECTRONS DANS UN MATERIAU NON-CONDUCTEUR

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Application
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Abstract (en)
[origin: WO2006003328A1] The invention concerns a device for intrusion of H⁺ ions and electrons inside a non-conductive material (2) so as to promote their low-energy collisions. More particularly, the invention concerns a device for colliding at least one H⁺ ion and at least one electron from a hydrogen-containing compound (3) and at least one cathode (4). The invention is characterized in that it comprises at least one electromagnetic field generator for extracting said H⁺ ion from said hydrogen-containing compound (3) and transferring said H⁺ ion to said cathode (4); at least one non-conductive material positioned between at least part of said hydrogen-containing compound and said cathode, said collision being produced inside said non-conductive material (2).

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